GRSX6270-13

DDR3-1333, PC3-10600, Registered, ECC, 1.5V, 240-pin DIMMs

Products in Family

GRSX6270-13/2GB (1 x 2GB 1Rx4 DIMMs)
GRSX6270-813/2GB (1 x 2GB 2Rx8 DIMMs)
GRSX6270-13/4GB (1 x 4GB 2Rx4 DIMMs)
GRSX6270-13/8GB (1 x 8GB 2Rx4 DIMMs)

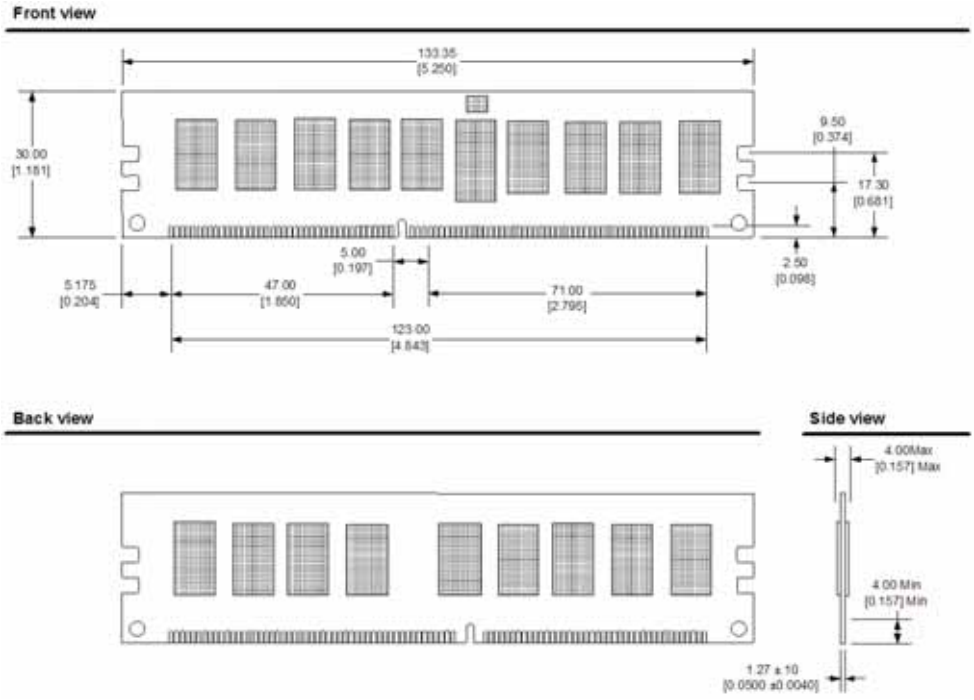
Features

240-pin JEDEC-compliant DIMMs
133.35 mm wide by 30 mm high (1.181" x 5.25")
Data Transfer Rate: 10.6 Gigabytes/sec
Operating Voltage: 1.5 V ±0.075
Fully RoHS Compliant
Thermal Sensor

Description

Each GRSX6270-13 upgrade consists of a single DDR3-1333 Registered ECC DIMM that conforms to JEDEC's DDR3, PC3-10600 standard. One 2K-bit EEPROM is used for Serial Presence Detect and a combination register/PLL with Address and Command Parity is also used. A thermal sensor accurately monitors the DIMM module and can prevent exceeding the maximum operating temperature of 95C.

Dataram Product	Sun Microsystems Product	Supported in these Sun Microsystems systems:
GRSX6270-13/2GB	X4653A	Sun Blade X6270 Server Module
GRSX6270-813/2GB	Not Offered by Sun	
GRSX6270-13/4GB	X4654A	
GRSX6270-13/8GB	Not Offered by Sun	



Notes

Tolerances on all dimensions except where otherwise indicated are ±.13 (.005).

All dimensions are expressed in millimeters [inches]

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